

Atomistic Green's Function Method: Density of States and Multi-dimensionality

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Based on:

W. Zhang, T.S. Fisher, N. Mingo, "The Atomistic Green's Function Method: An Efficient Simulation Approach for Nanoscale Phonon Transport," *Numerical Heat Transfer: Part B (Fundamentals)*, Vol. 51, No. 3/4, pp. 333-349, 2007.

Density of States Definitions

- Recall the phonon density of states that gives the number of modes per unit frequency per unit volume of real space

$$D(\omega) = \frac{1}{L^{\alpha=1}} \frac{dN}{d\omega} = \frac{1}{L} \frac{dN}{dK} \frac{dK}{d\omega} = \frac{1}{\pi} \frac{1}{d\omega/dK} = \left[\pi a \sqrt{\frac{g}{m} - \frac{\omega^2}{4}} \right]^{-1}$$

- Proof** $\omega = 2\sqrt{\frac{g}{m}} \sin\left(\frac{Ka}{2}\right) \rightarrow \frac{d\omega}{dK} = a\sqrt{\frac{g}{m}} \cos\left(\frac{Ka}{2}\right)$

$$a\sqrt{\frac{g}{m} - \frac{\omega^2}{4}} = a\sqrt{\frac{g}{m} - \frac{g}{m} \sin^2\left(\frac{Ka}{2}\right)}$$

$$= a\sqrt{\frac{g}{m}} \cos\left(\frac{Ka}{2}\right)$$

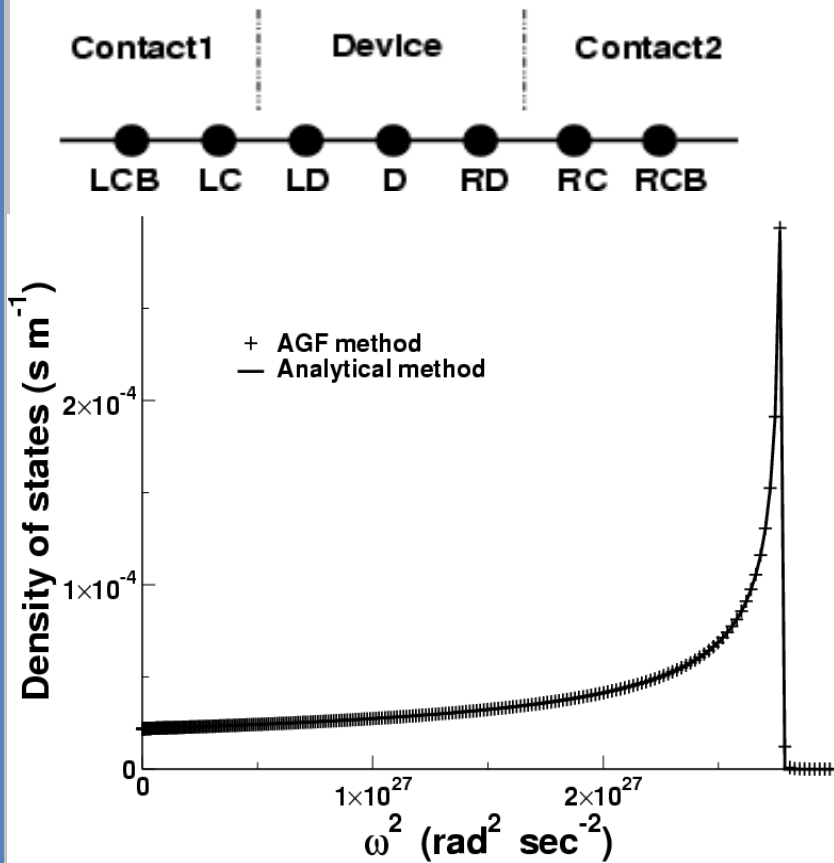
Relation to AGF

- The Green's function inherently contains the local density of states

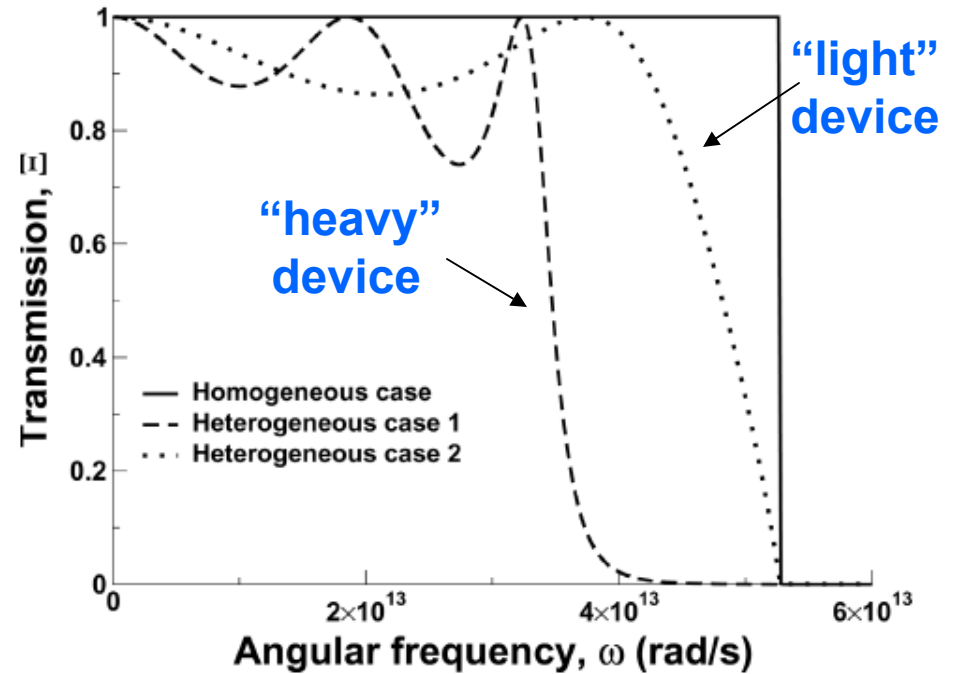
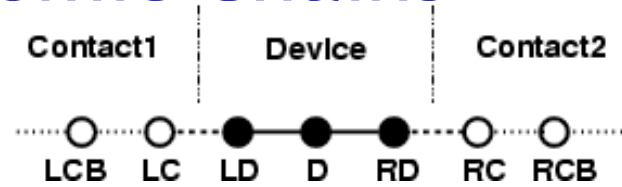
$$\mathbf{D}_I(\omega) = \frac{i(\mathbf{G} - \mathbf{G}^\dagger)\omega}{\pi a}$$

- The local density of states of the i th degree of freedom is the i th diagonal element of \mathbf{D}_I
- The global density of states function is the same as the local density of states in homogeneous materials

Results for Simple Atomic Chains



Homogeneous chain density of states

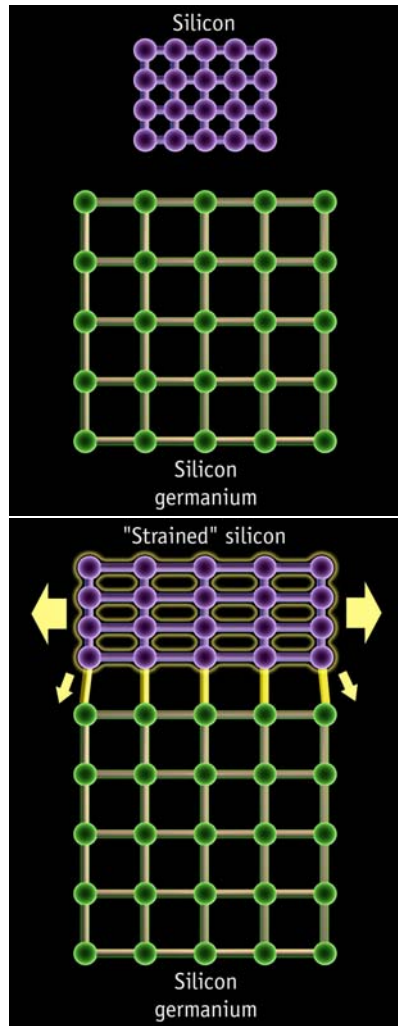


Contact atomic masses = $4.6 \times 10^{-26} kg$
 Heavy device masses = $9.2 \times 10^{-26} kg$
 Light device masses = $2.3 \times 10^{-26} kg$

Multi-dimensional AGF

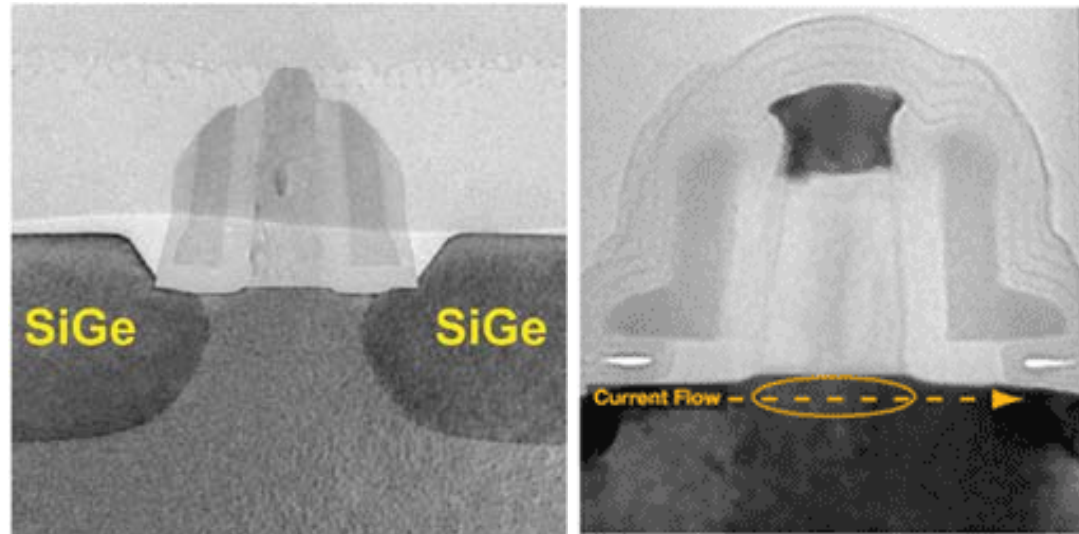
Strained Silicon

T. Ghani, et al. at IEDM 2003



PMOS

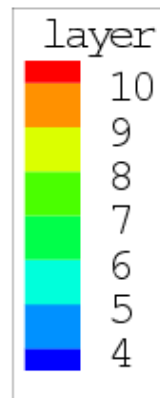
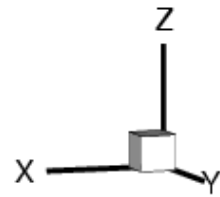
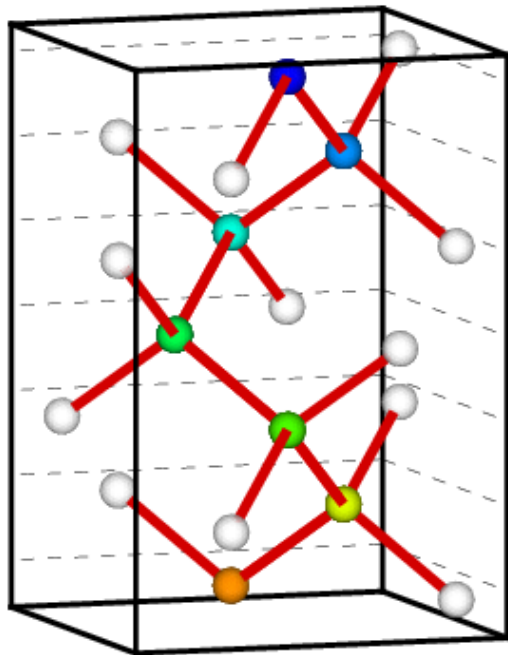
NMOS



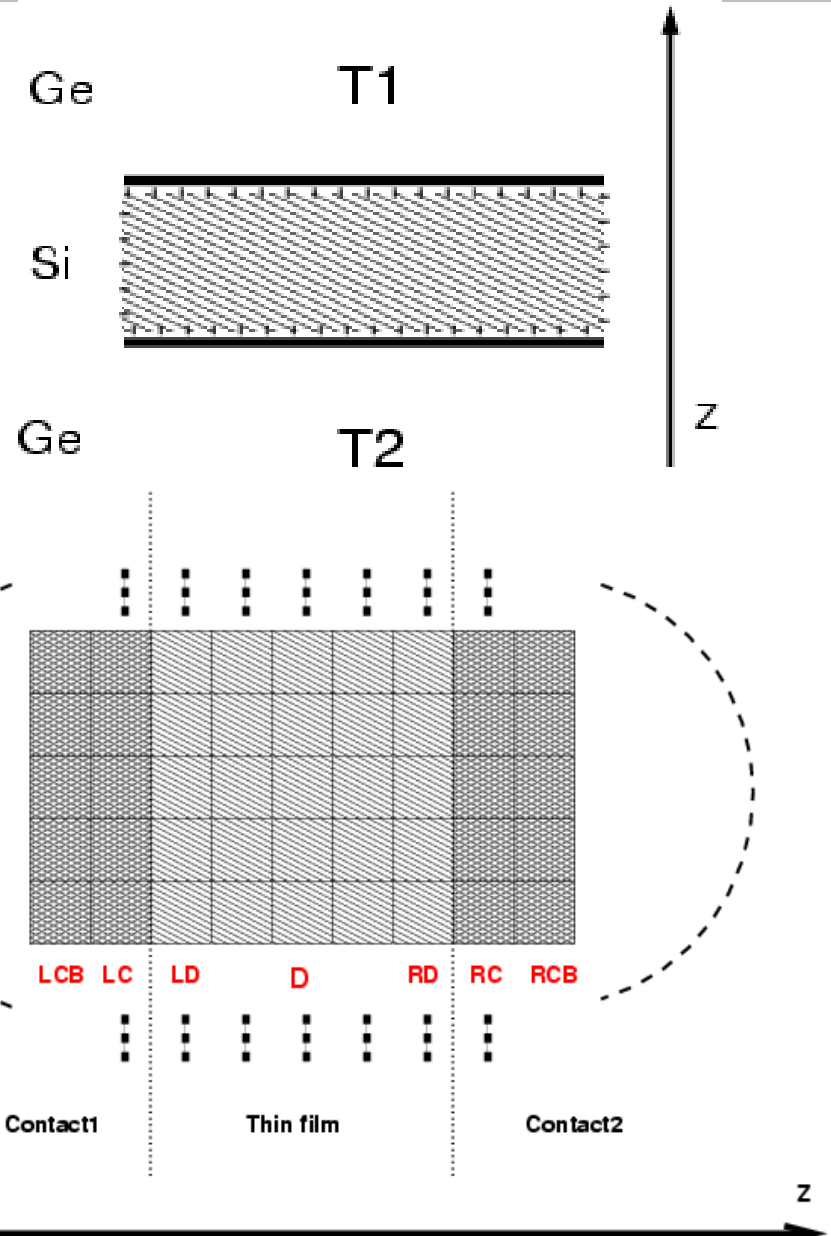
25 % drive current increase in PMOS;
10 % drive current increase in NMOS

<http://www.research.ibm.com/resources/press/strainedsilicon/>

Thin Films



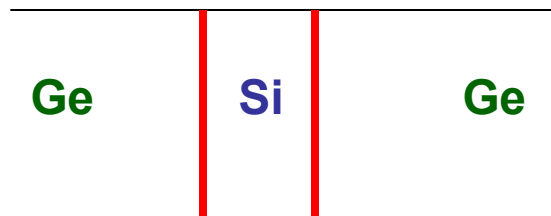
Transport along the (100) direction
(i.e., the z direction)



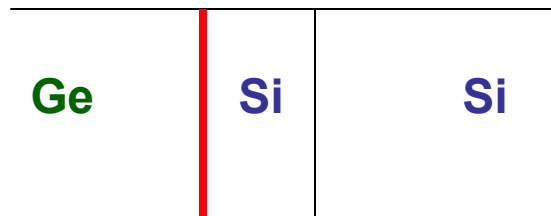
z

Model/Code Validation

Convert Ge/Si/Ge

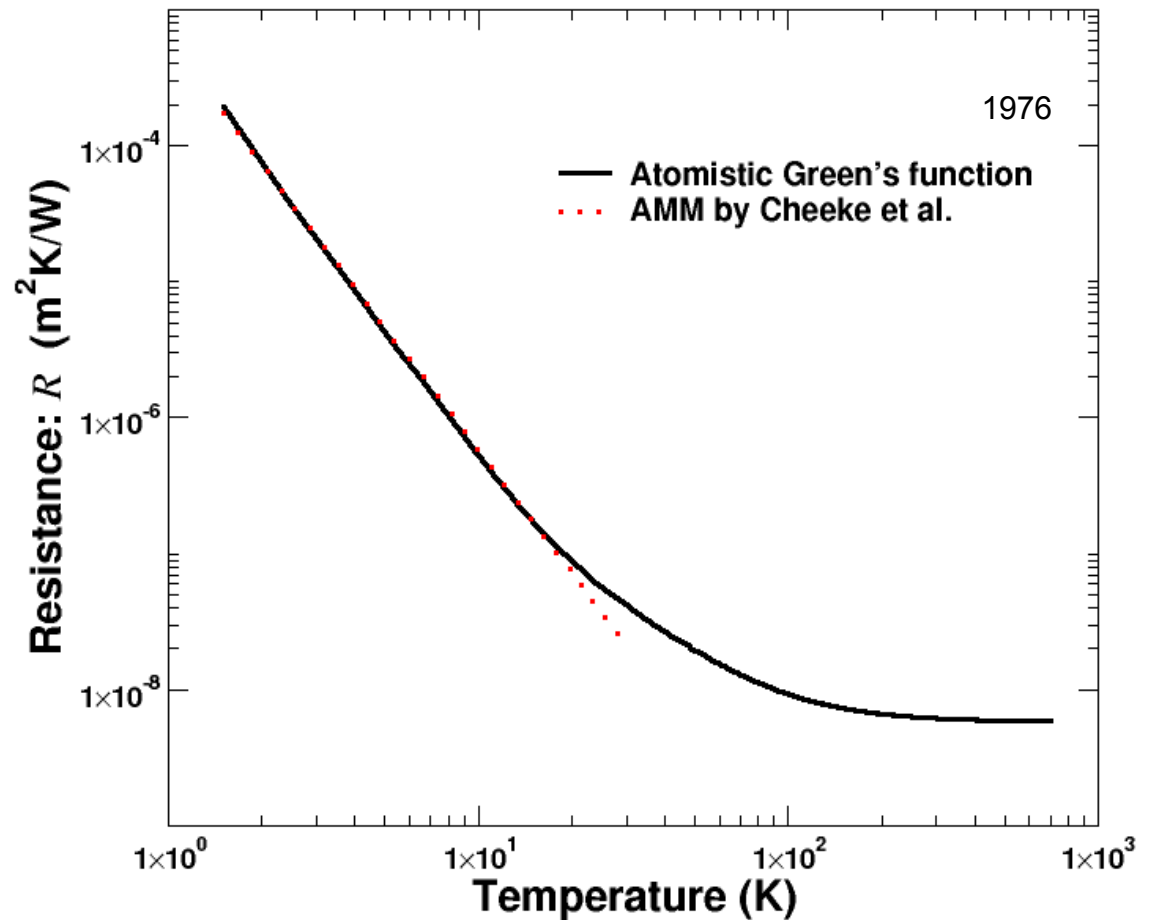


to Ge/Si/Si



to create a single interface.

Zhang et al., J. Heat Trans. in review

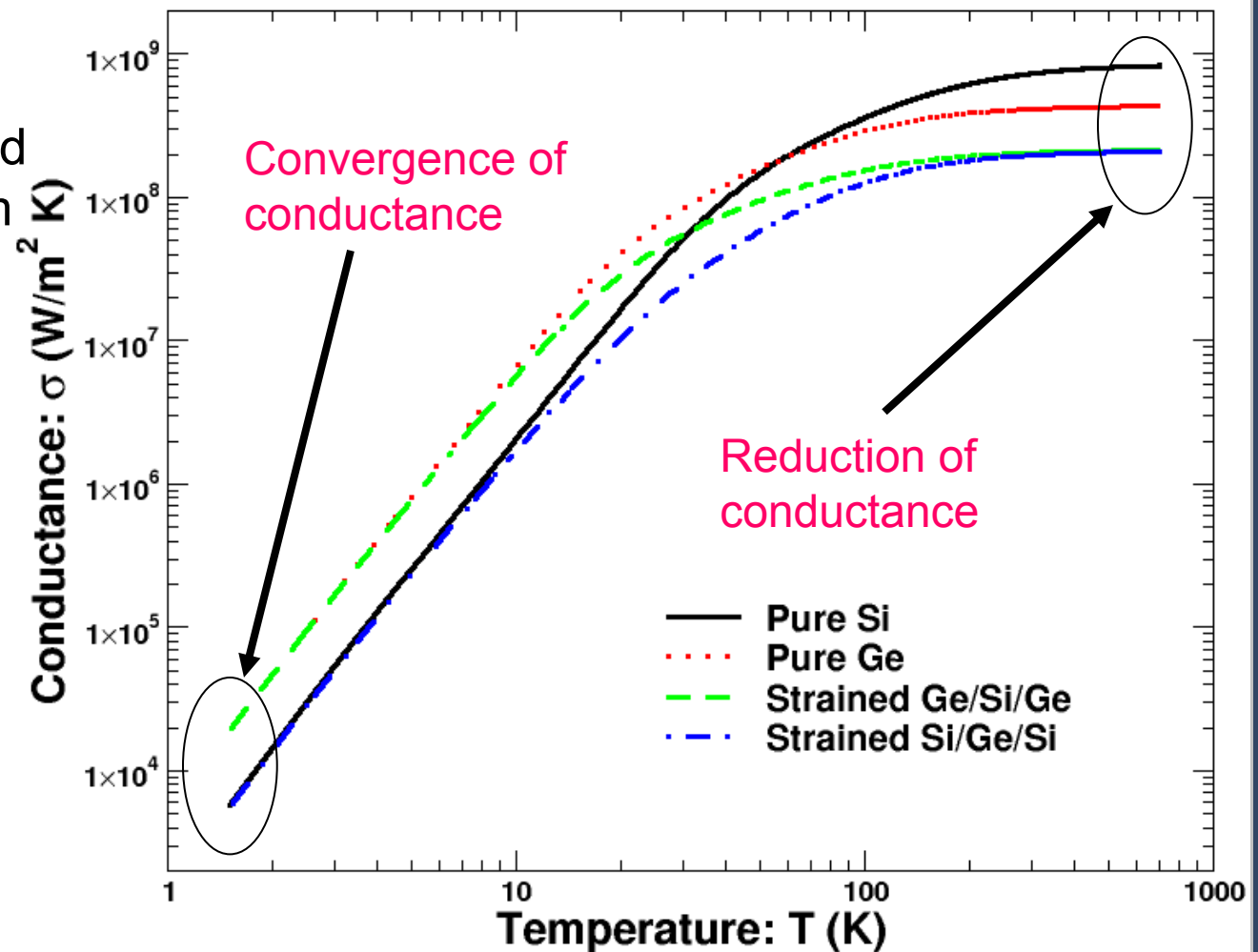


AMM is known to work well at low temperatures

Thermal Conductance

Conductance reduced by 30 to 50% at room temperatures due to heterogeneous interfaces

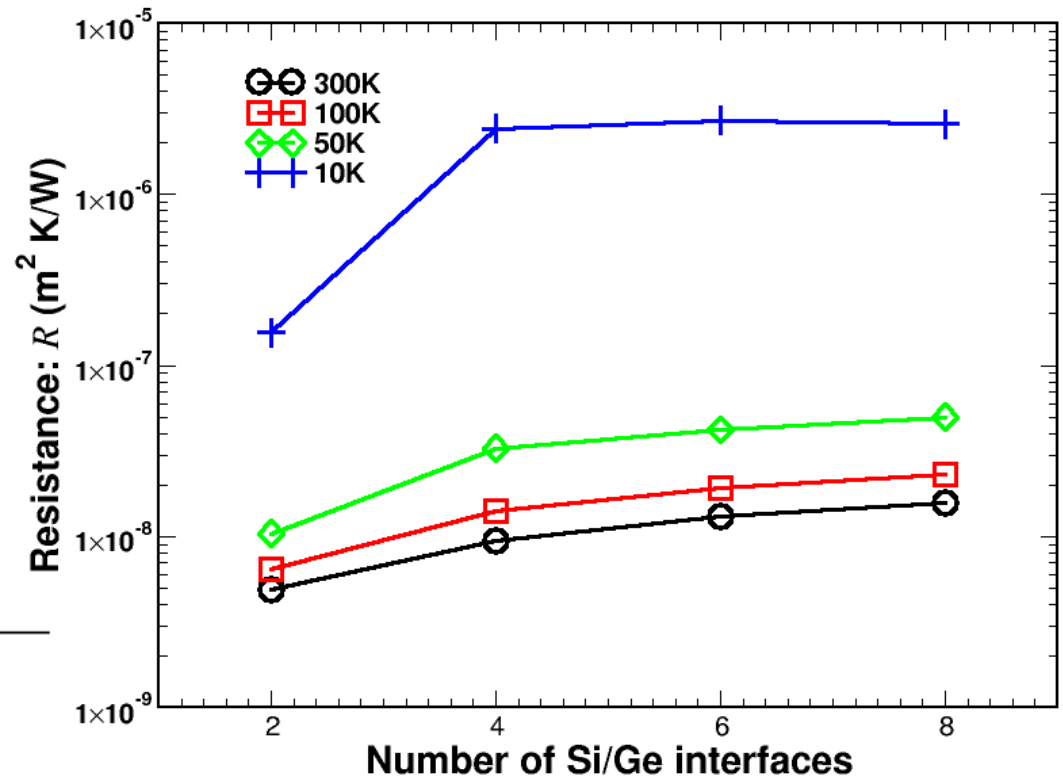
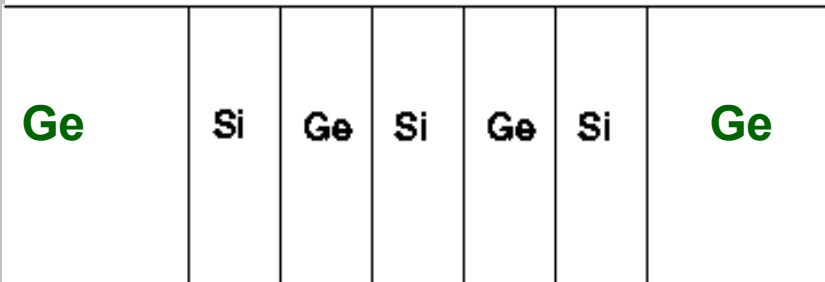
At low temperatures, conductance converges to that of the bulk contacts



Multilayer Effects



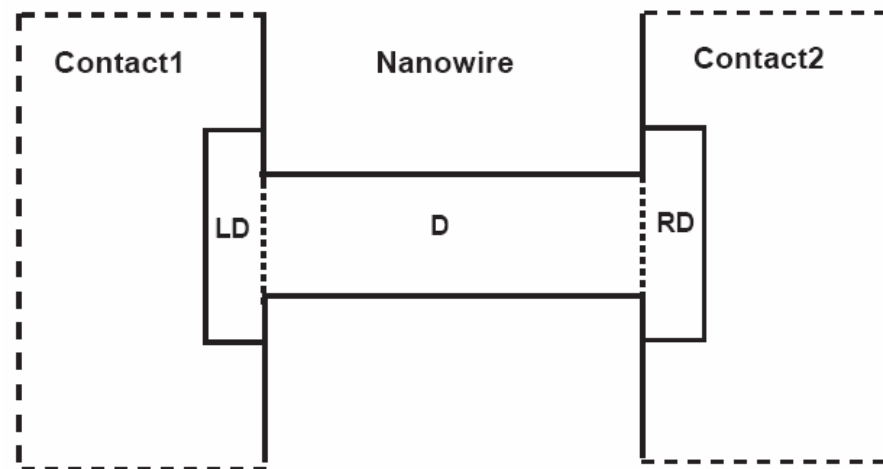
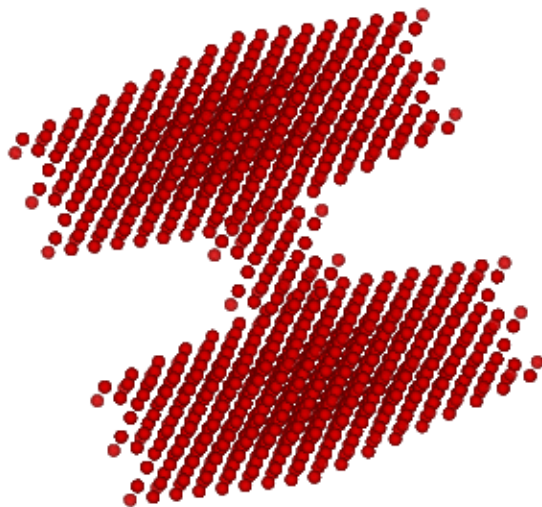
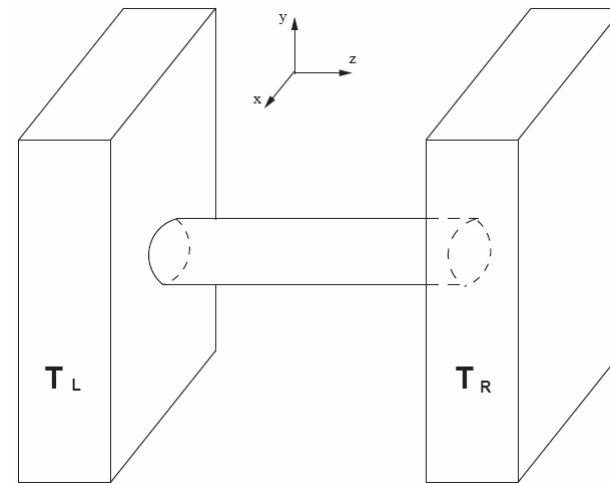
Replace the Si device with a multi-layer structure



Asymptotic behavior is similar to that of radiation shields

Nanowire-plane Structure

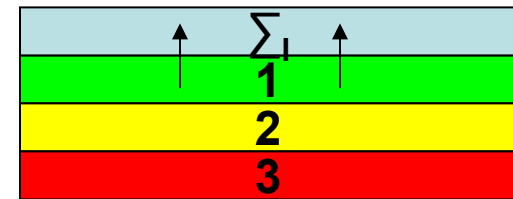
- Nanowires are building blocks for many nanoscale devices and are usually connected to bulk contacts



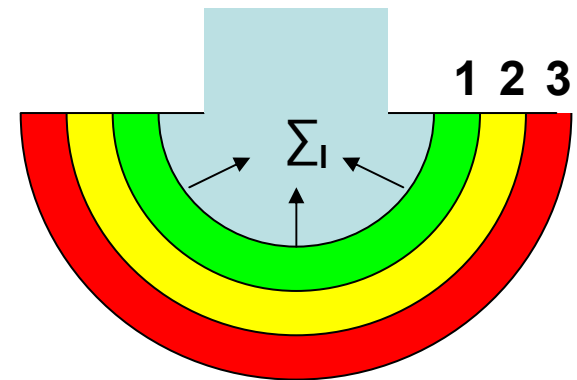
Evaluation of the Self-energy Matrix Σ

- Traditional method (decimation technique) to evaluate the self-energy matrix is difficult to implement at the nanowire-plane interface
 - ◆ Layers have different numbers of atoms as well as shifted atomic locations
 - ◆ Interactions within layers and interactions between layers are difficult to evaluate
- New method is universal for any abruptly changing geometry
 - ◆ Use bare surface g_0 on flat surface
$$\tilde{g}_o = (\omega^2 \mathbf{I} - \mathbf{H}_{LDm} - \Sigma_L)^{-1}$$
 - ◆ Σ_L is the same no matter whether it is attached to nanowire or just a flat bare surface

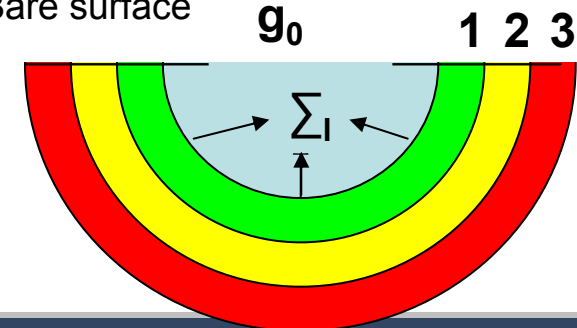
Thin film



Nanowire-plane



Bare surface



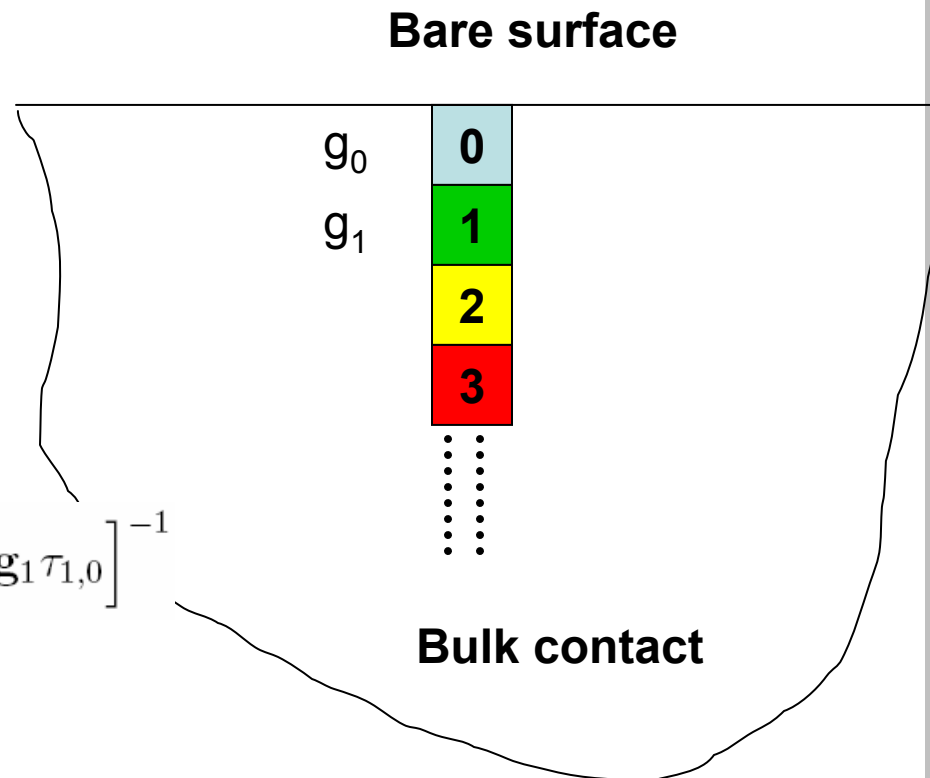
Bare Surface Green's Function

- Each layer is represented by one unit cell with planewave formulation, as in thin-film case
- Use decimation technique (a universal algorithm) to obtain g_1 and then evaluate g_0

$$g_0(\omega, \vec{k}_{\parallel}) \equiv \lim_{\delta \rightarrow 0} \left[(\omega^2 + \delta i) \mathbf{I} - \mathbf{H}_0(\vec{k}_{\parallel}) - \tau_{0,1} \mathbf{g}_1 \tau_{1,0} \right]^{-1}$$

- With g_0 known, we can find Σ_L

$$\Sigma_L = \omega^2 \mathbf{I} - \mathbf{H}_{LDm} - \tilde{g}_o^{-1}$$



Harmonic Matrix and Dispersion

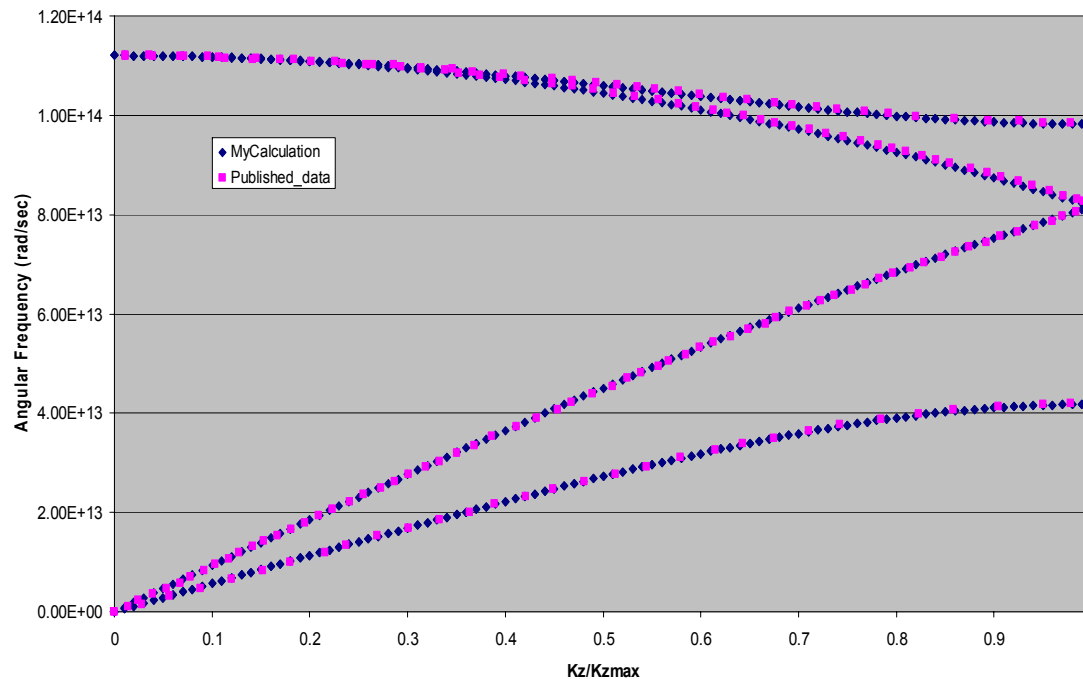
- Requirements:

- ◆ Atom locations
- ◆ Force between two atoms in

$$\mathbf{H} = \{H_{ij}\} = \frac{1}{\sqrt{M_i M_j}} \begin{cases} \frac{\partial^2 U}{\partial u_i \partial u_j}, & \text{if } i \neq j \\ - \sum_{m \neq j} \frac{\partial^2 U}{\partial u_j \partial u_m}, & \text{if } i = j \end{cases}$$

- Benchmark against published theoretical **bulk** dispersion curves

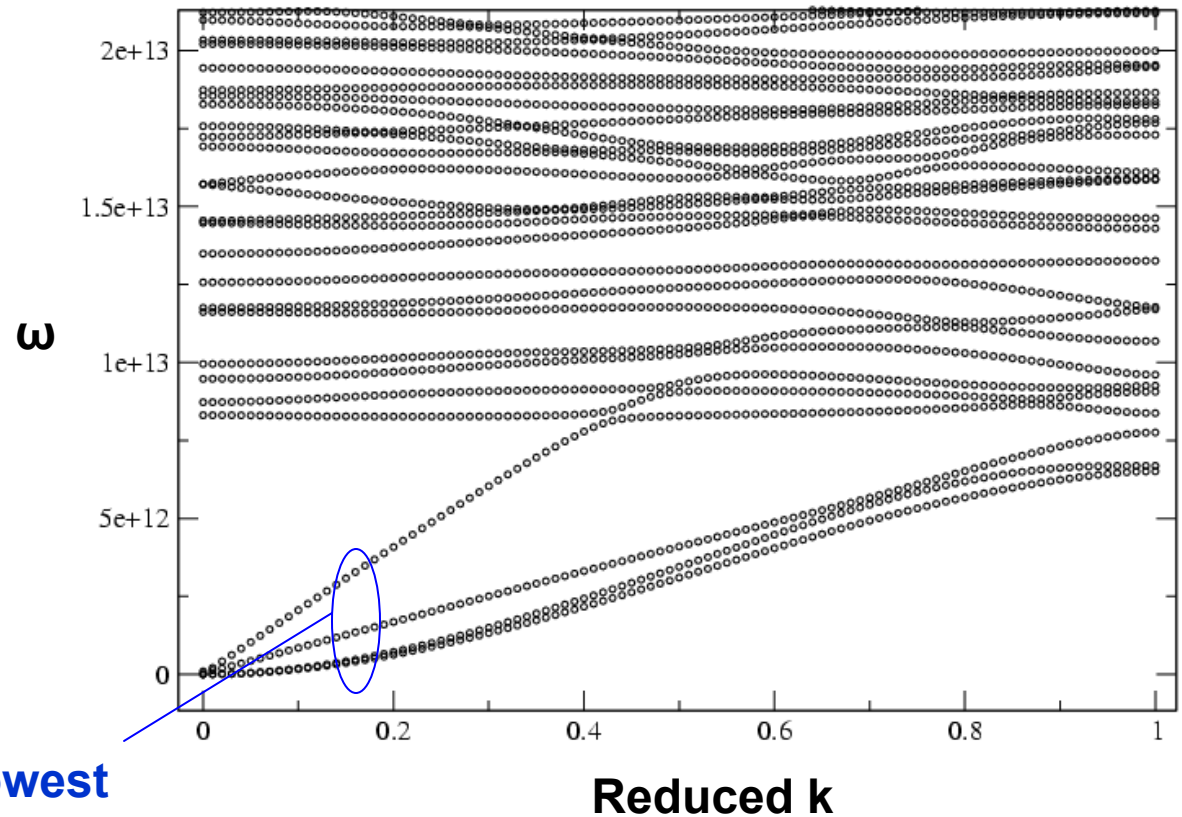
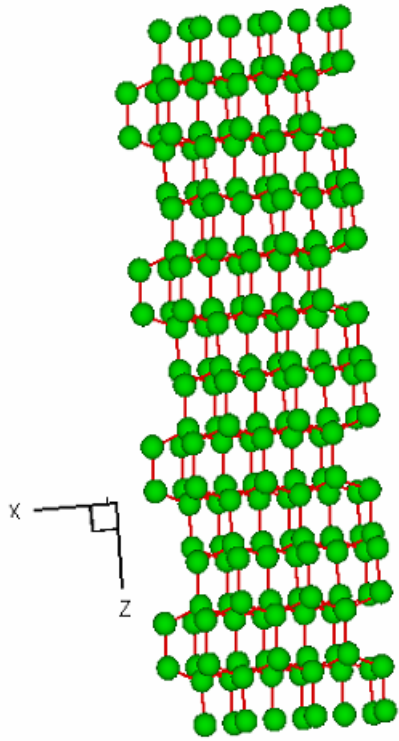
Dispersion Curve on silicon 100



L.J. Porter, *et.al.* J Appl Phys 82(5378), 1997

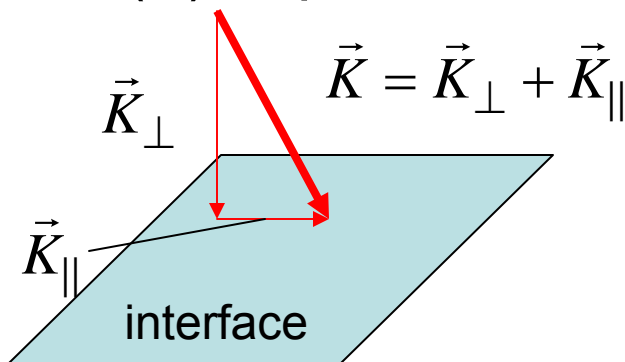
Dispersion of Infinite Nanowires

Orientation: (111)



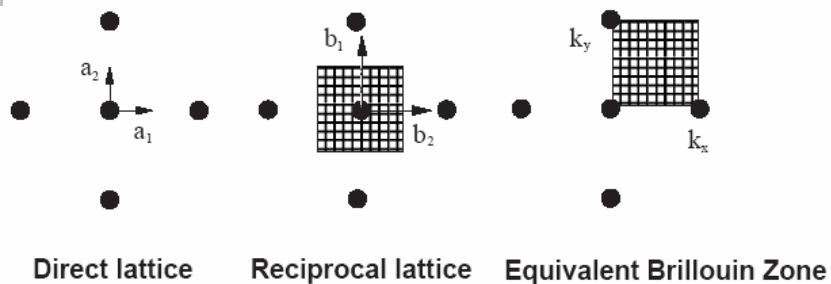
Integration over K-parallel Space

- Phonon transmission (Ξ) depends on frequency and direction

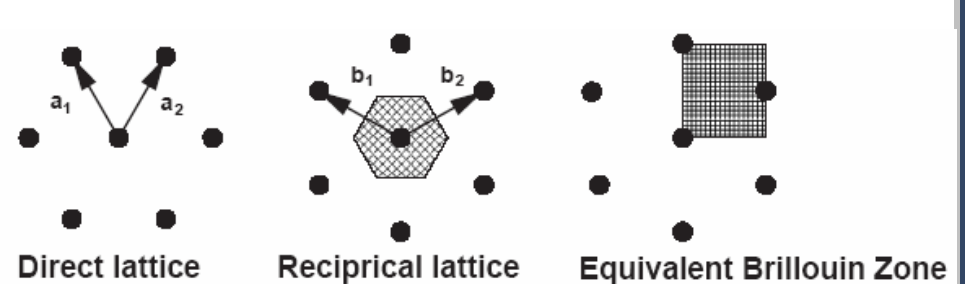


- K_{\parallel} mesh is chosen so that doubling mesh density changes thermal conductance within 3%

(100) direction



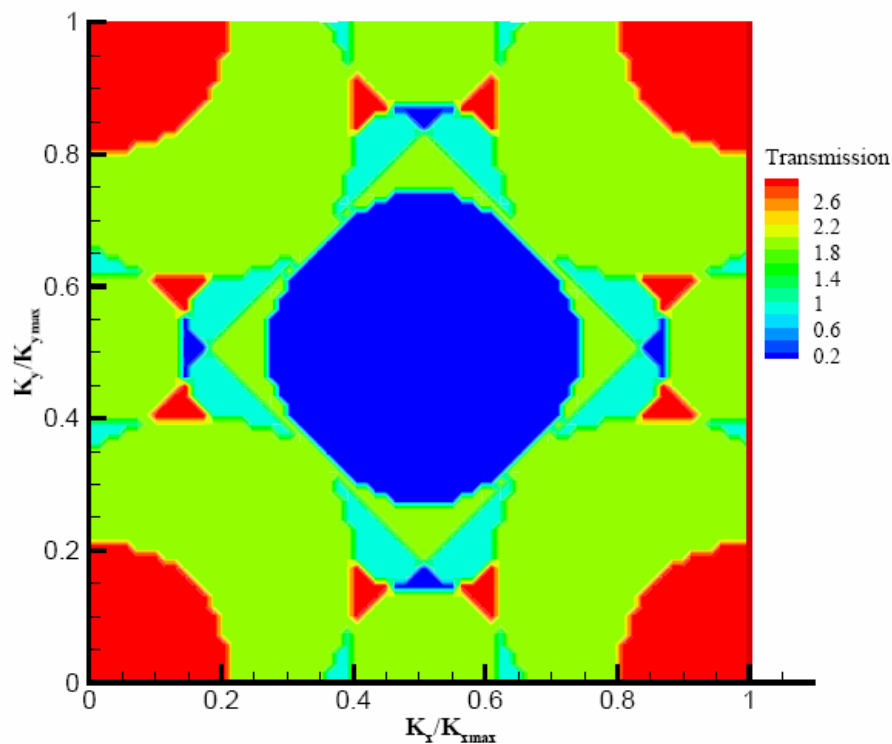
(111) direction



Transmission Distribution

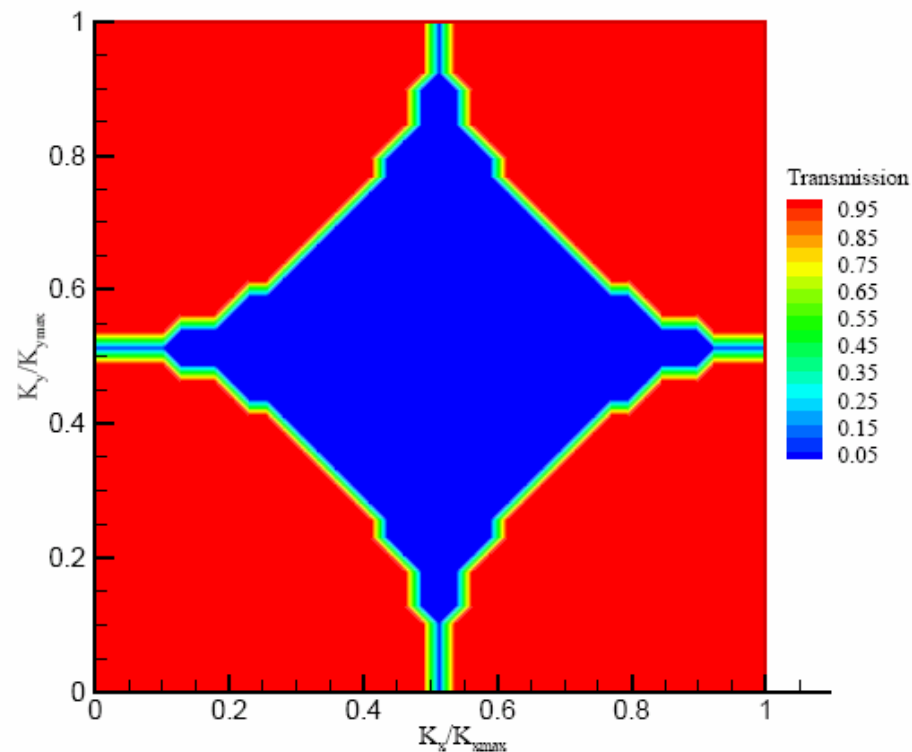
**Low-frequency
Phonons
(2.4×10^{13} rad/sec)**

High transmission
confined to corners of
K-space



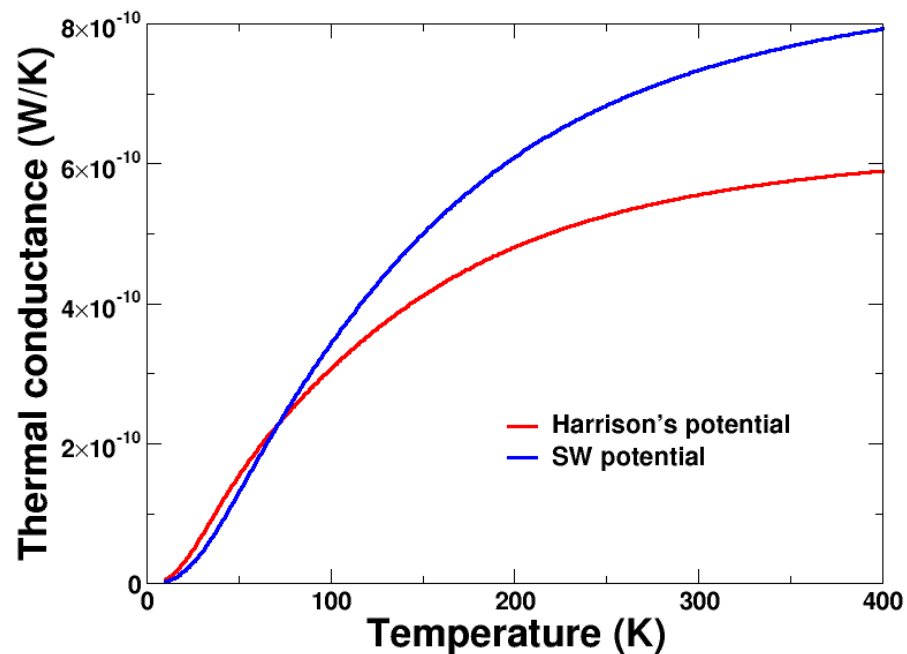
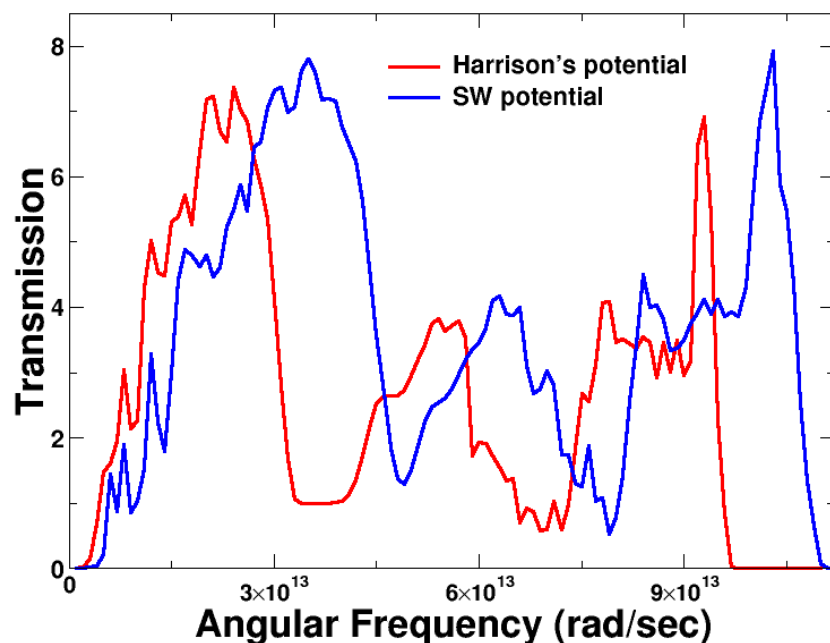
**Higher-frequency
Phonons
(5.0×10^{13} rad/sec)**

High transmission
extends into middle of
K-space

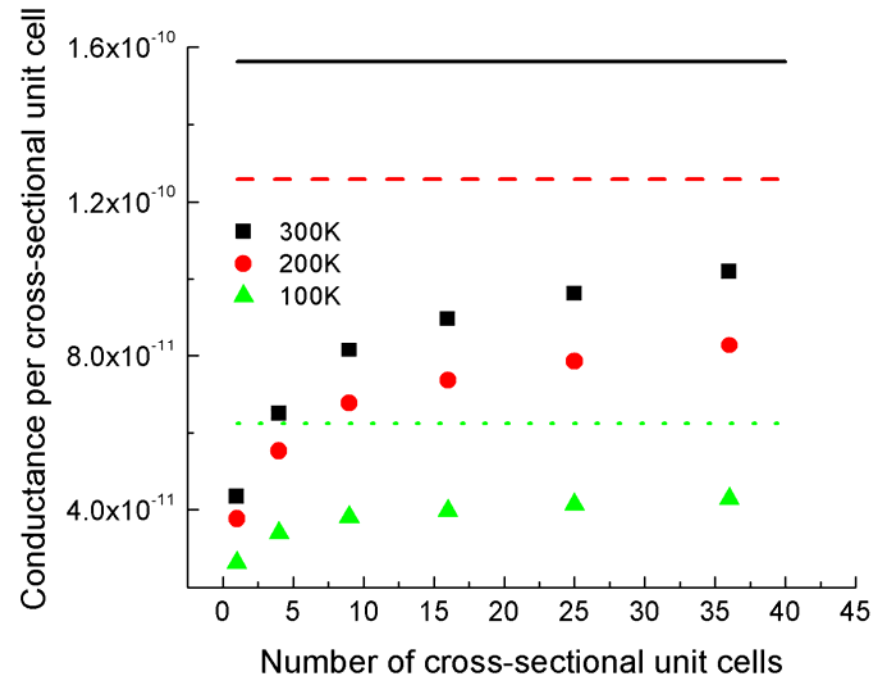
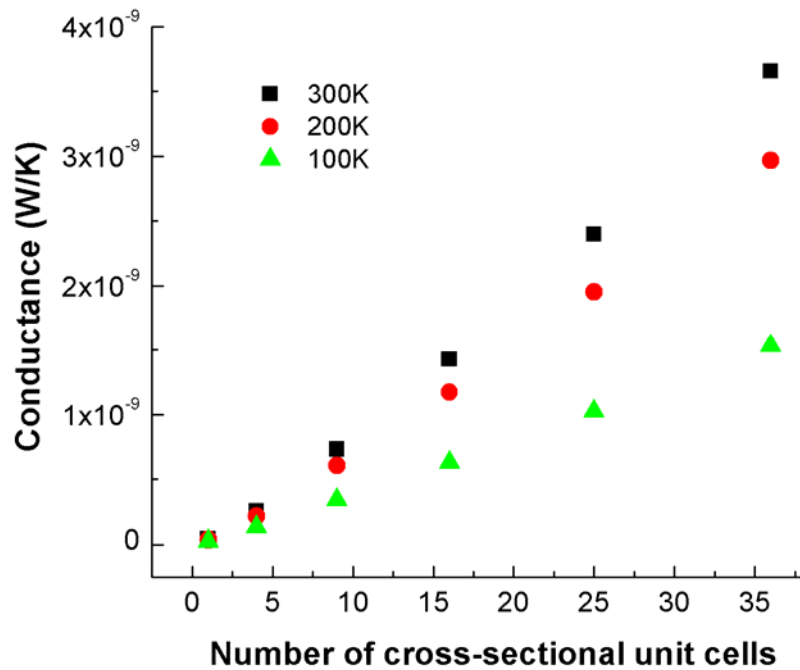
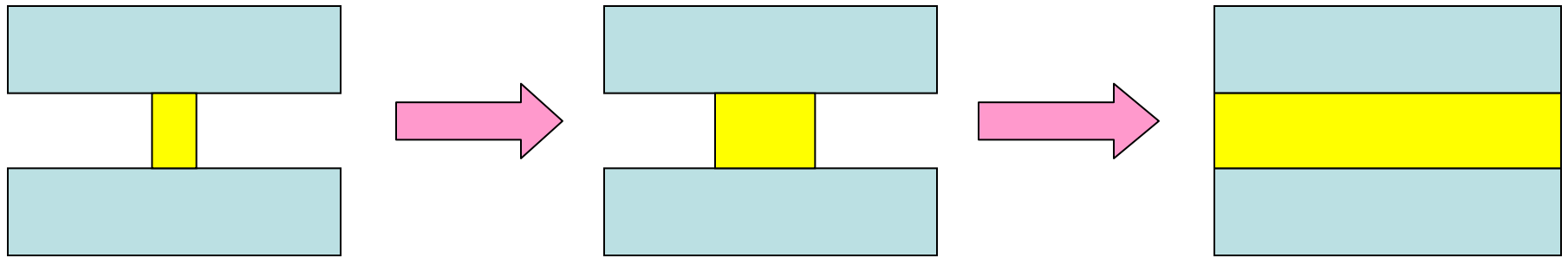


Choice of Potential Function

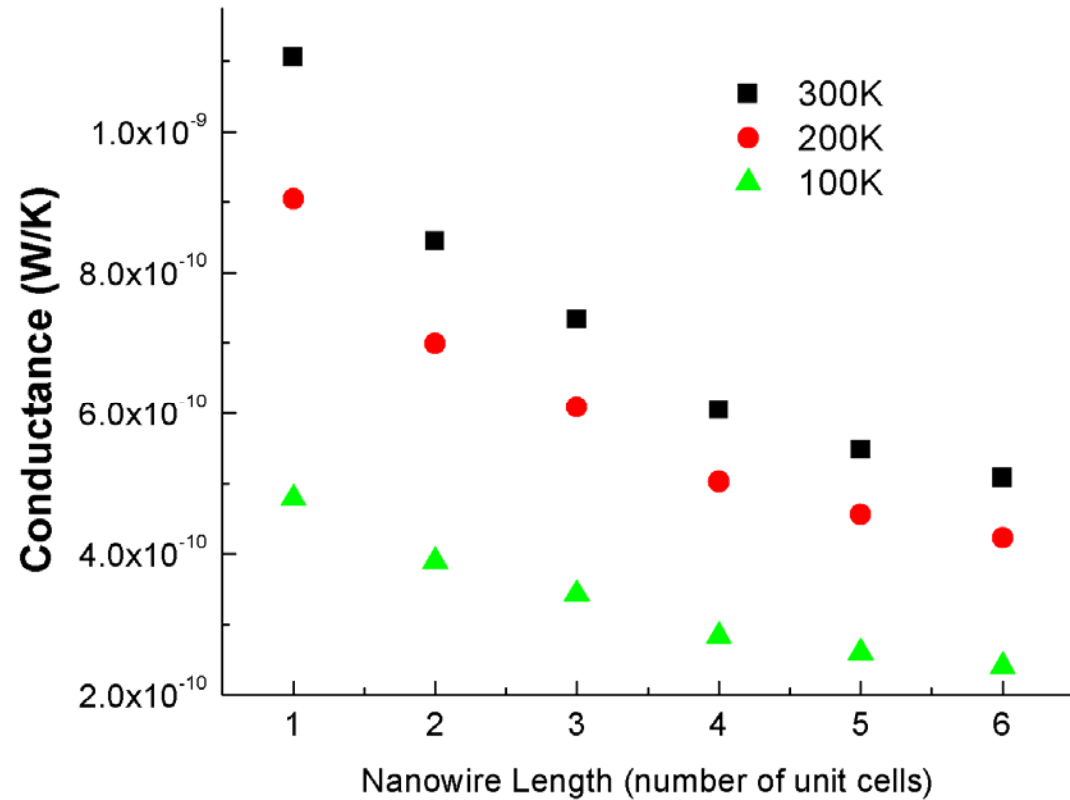
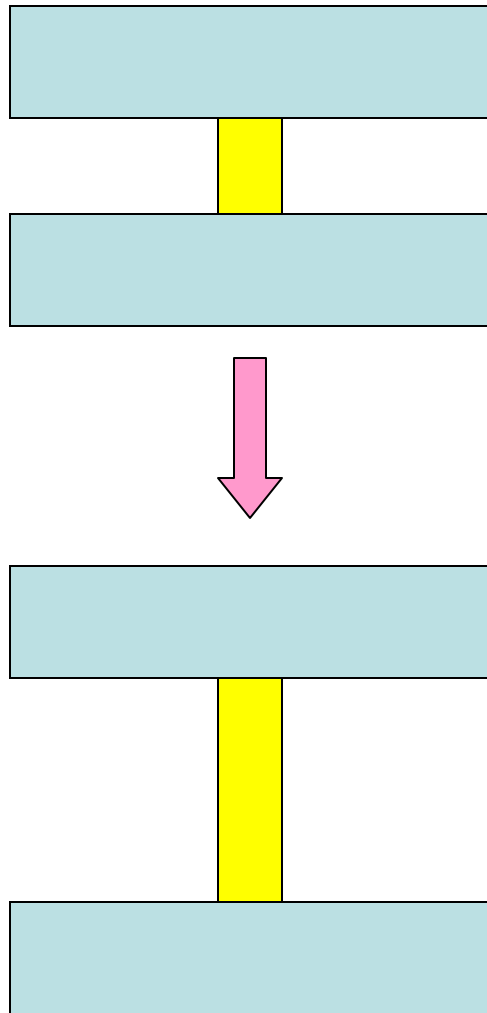
- 3 unit cells per layer; 3 unit cells long nanowire-plane structure
- Use Harrison's and Stillinger-Weber potentials



Diameter Dependence

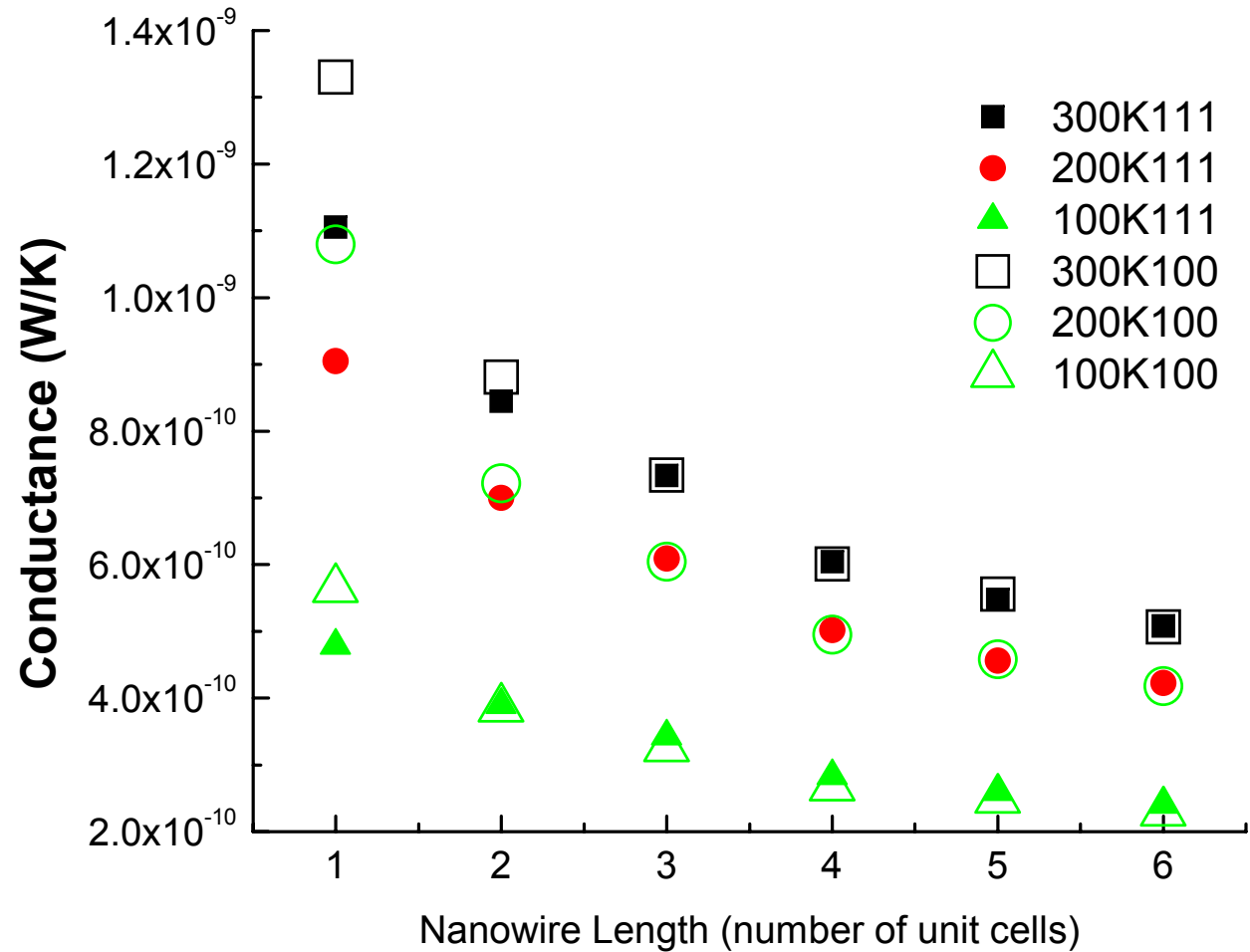


Length Dependence



Orientation Dependence

- Comparison of (111) and (100) orientations



Conclusions

- The AGF method is an effective tool in simulating ballistic phonon transport through relevant interfaces involving bulk and nanoscale materials
- Strain effects are small compared to heterogeneous-material effects
- A heterogeneous device layer reduces thermal conductance significantly at room temperature
- Increasing film thickness decreases thermal conductance
- The first few heterogeneous interfaces are most responsible for decreasing thermal conductance

Acknowledgements

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- Dr. Natalio Mingo, NASA AMES
- Prof. Jayathi Murthy, Purdue
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